

MH 248 Hall-effect sensor is a temperature stable, stress-resistant , micro-power switch. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization. This method reduces the offset voltage normally caused by device over molding, temperature dependencies, and thermal stress.

The MH 248 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short circuit protected open-drain output. Advanced CMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

This device requires the presence of omni-polar magnetic fields for operation.

The MH 248 is rated for operation between the ambient temperatures  $-40^{\circ}\text{C}$  and  $+85^{\circ}\text{C}$  for the E temperature range. The four package styles available provide magnetically optimized solutions for most applications. Package types SO is an SOT-23(1.1 mm nominal height),ST is an Tsot-25(0.8 mm nominal height),SU is an USON(0.5 mm nominal height) ,a miniature low-profile surface-mount package, while package UA is a three-lead ultramini SIP for through-hole mounting.

The package type is in a lead (Pb)-free/ Green version was verified by third party Lab.

### ***Features and Benefits***

- CMOS Hall IC Technology
- Solid-State Reliability
- Micro power consumption for battery-powered applications
- Omni polar, output switches with absolute value of North or South pole from magnet
- Operation down to 2.5V
- High Sensitivity for direct reed switch replacement applications
- Multi Small Size option
- Custom sensitivity selection is available in optional package.
- Pb Free/Green chip is qualified by third party lab.

### ***Applications***

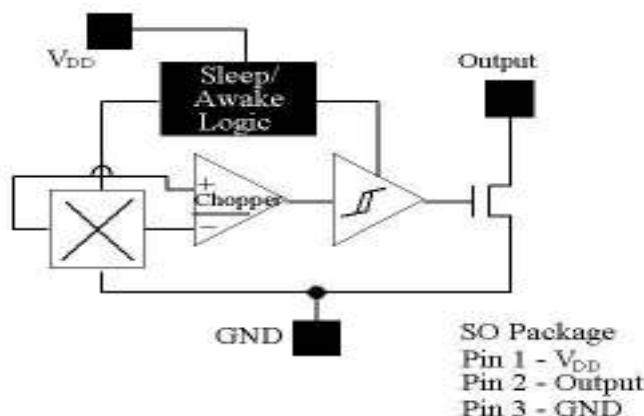
- Solid state switch
- Handheld Wireless Handset Awake Switch
- Flip Cell/PHS Phone/Note Book/Flip Video Set
- PDVD/DC/DV/GPS
- Liquid detection
- Game machine/Position detection
- Lid close sensor for battery powered devices
- Magnet proximity sensor for reed switch replacement in low duty cycle applications

**Ordering Information**

|                                  |  |
|----------------------------------|--|
| <b>XX-XXX X XX-X-XX XX-X</b><br> | <b>Company Name and Product Category</b><br>MH:MST Hall Effect/MP:MST Power MOSFET<br><b>Part number</b><br>181,182,183,185,248,249,481,482...<br><b>Temperature range</b><br>E: 85 Degree C, K: 125 Degree C, L: 150 Degree C<br><b>Package type</b><br>UA:TO-92S,SO:SOT-23,ST:Tsot-25,SU:USON<br><b>Sorting</b><br>$\alpha, \beta$ ,Blank.....<br><b>Package Identification Code</b><br>01,02,03.....<br><b>Handling Code</b><br>BLANK: ESD bag, TR: Tape & Reel<br><b>Lead Free Code</b><br>BLANK: Lead Free Device ,G: Green |
|----------------------------------|--|

| Part No. | Temperature Suffix  | Package Type  | Package Identification |
|----------|---------------------|---------------|------------------------|
| 248      | E (-40°C to + 85°C) | UA ( TO-92S)  | 01                     |
|          | E (-40°C to + 85°C) | SO (SOT-23)   | 05                     |
|          | E (-40°C to +85°C)  | ST ( TSOT-25) | 06                     |
|          | E (-40°C to +85°C)  | SU ( USON)    | 07                     |

- Custom sensitivity selection is available

**Functional Diagram**


Note: Static sensitive device; please observe ESD precautions. Reverse V<sub>DD</sub> protection is not included. For reverse voltage protection, a 100Ω resistor in series with V<sub>DD</sub> is recommended.



Magnesensor Technology

MH 248

High Sensitivity CMOS Micropower Hall Switch

**Absolute Maximum Ratings**

|   |                 |
|---|-----------------|
| Supply Voltage (Operating), V <sub>DD</sub> | 5V              |
| Supply Current (Fault), I <sub>DD</sub>     | 5mA             |
| Output Voltage, V <sub>OUT</sub>            | 5V              |
| Output Current (Fault), I <sub>OUT</sub>    | 5mA             |
| Operating Temperature Range, T <sub>A</sub> | -40°C to +85°C  |
| Storage Temperature Range, T <sub>S</sub>   | -55°C to +150°C |

**Electrical Specifications**DC operating parameters: T<sub>A</sub> = 25°C, V<sub>DD</sub>=3V<sub>DC</sub> (unless otherwise specified).

| Parameter            | Symbol           | Test Conditions        | Min. | Typ.  | Max. | Units |
|----------------------|------------------|------------------------|------|-------|------|-------|
| Supply Voltage       | V <sub>DD</sub>  | Operating              | 2.5  |       | 3.5  | V     |
| Supply Current       | I <sub>DD</sub>  | Average                |      | 8.0   |      | µA    |
| Awake supply Current |                  | Awake On               |      | 1.5   |      | mA    |
| Output Current       | I <sub>OUT</sub> |                        |      |       | 1.0  | mA    |
| Saturation Voltage   | V <sub>SAT</sub> | I <sub>OUT</sub> = 1mA |      |       | 0.4  | V     |
| Awake mode time      | T <sub>AW</sub>  | Operating              |      | 175.0 |      | µS    |
| Sleep mode time      | T <sub>SL</sub>  | Operating              |      |       | 70.0 | mS    |

**MH248ESO/UA/ST/SU-STD Magnetic Specifications**DC operating parameters: T<sub>A</sub> = 25°C, V<sub>DD</sub>=3V<sub>DC</sub> (unless otherwise specified).

| Parameter       | Symbol           | Test Conditions                                | Min  | Typ | Max. | Units |
|-----------------|------------------|--|------|-----|------|-------|
| Operating Point | B <sub>OPS</sub> | Refer to Output Behavior versus Magnetic Polar | 0.6  |     | 6.0  | mT    |
|                 | B <sub>OPN</sub> | Refer to Output Behavior versus Magnetic Polar | -6.0 |     | -0.6 | mT    |
| Release Point   | B <sub>RPS</sub> | Refer to Output Behavior versus Magnetic Polar | 0.5  |     | 5.9  | mT    |
|                 | B <sub>RPN</sub> | Refer to Output Behavior versus Magnetic Polar | -5.9 |     | -0.5 | mT    |
| Hysteresis      | B <sub>HYS</sub> | B <sub>OPX</sub> - B <sub>RPX</sub>            |      | 0.7 |      | mT    |

**Note:** 1 mT = 10 Gauss.**MH248ESO/UA/ST/SU- $\alpha$  Magnetic Specifications**DC operating parameters: T<sub>A</sub> = 25°C, V<sub>DD</sub>=3V<sub>DC</sub> (unless otherwise specified).

| Parameter       | Symbol           | Test Conditions                                | Min. | Typ. | Max. | Units |
|-----------------|------------------|--|------|------|------|-------|
| Operating Point | B <sub>OPS</sub> | Refer to Output Behavior versus Magnetic Polar | 2.1  |      | 4.0  | mT    |
|                 | B <sub>OPN</sub> |  | -6.0 |      | -0.6 | mT    |
| Release Point   | B <sub>RPS</sub> | Refer to Output Behavior versus Magnetic Polar | 2.0  |      | 3.9  | mT    |
|                 | B <sub>RPN</sub> |  | -5.9 |      | -0.5 | mT    |
| Hysteresis      | B <sub>HYS</sub> | B <sub>OPX</sub> - B <sub>RPX</sub>            |      | 0.7  |      | mT    |

**Note:** 1 mT = 10 Gauss.

**MH248ESO/UA/ST/SU- $\gamma$  Magnetic Specifications**

 DC operating parameters:  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3\text{V}_{DC}$  (unless otherwise specified).

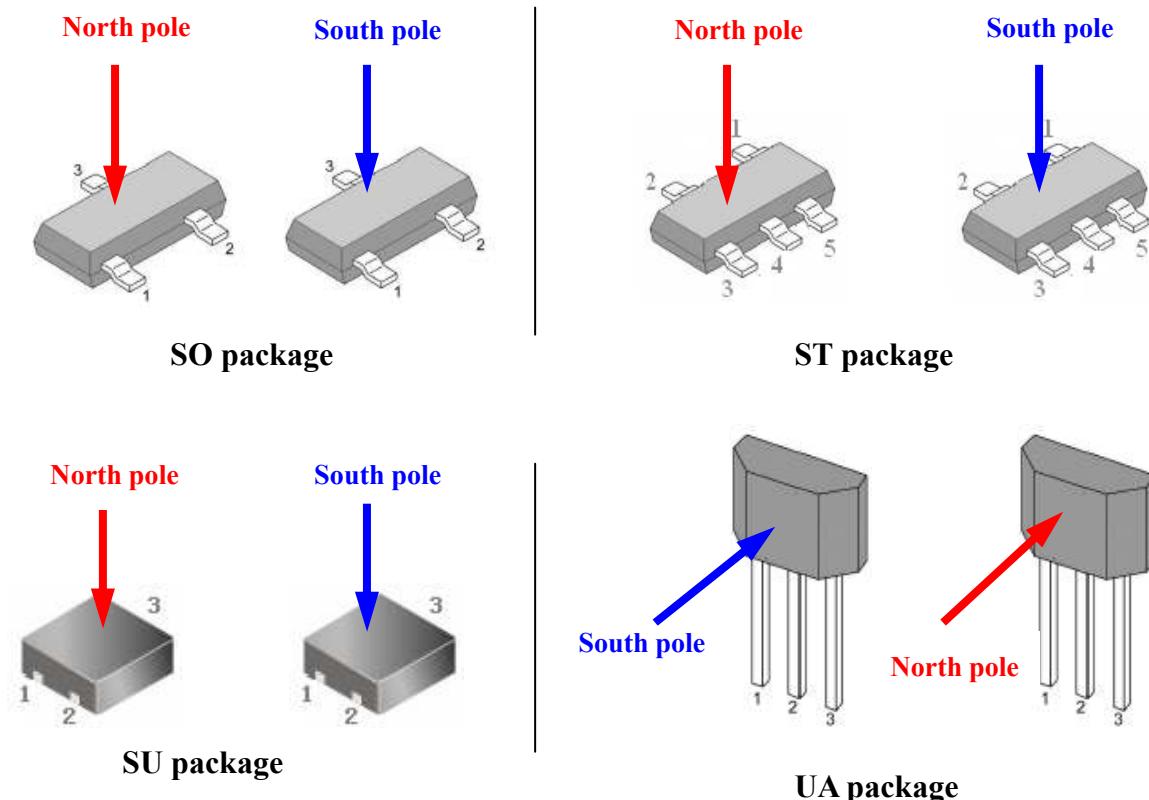
| Parameter       | Symbol    | Test Conditions                                | Min. | Typ. | Max. | Units |
|-----------------|-----------|--|------|------|------|-------|
| Operating Point | $B_{OPS}$ | Refer to Output Behavior versus Magnetic Polar | 0.6  |      | 3.5  | mT    |
|                 | $B_{OPN}$ |  | -6.0 |      | -0.6 | mT    |
| Release Point   | $B_{RPS}$ | Refer to Output Behavior versus Magnetic Polar | 0.5  |      | 3.4  | mT    |
|                 | $B_{RPN}$ |  | -5.9 |      | -0.5 | mT    |
| Hysteresis      | $B_{HYS}$ | $ B_{OPX} - B_{RPX} $                          |      | 0.7  |      | mT    |

Note: 1 mT = 10 Gauss.

**MH248ESO/UA/ST/SU-STD Output Behavior versus Magnetic Polar**

 DC Operating Parameters  $T_a = -40$  to  $85^\circ\text{C}$ ,  $V_{dd} = 2.5$  to  $3\text{V}$ 

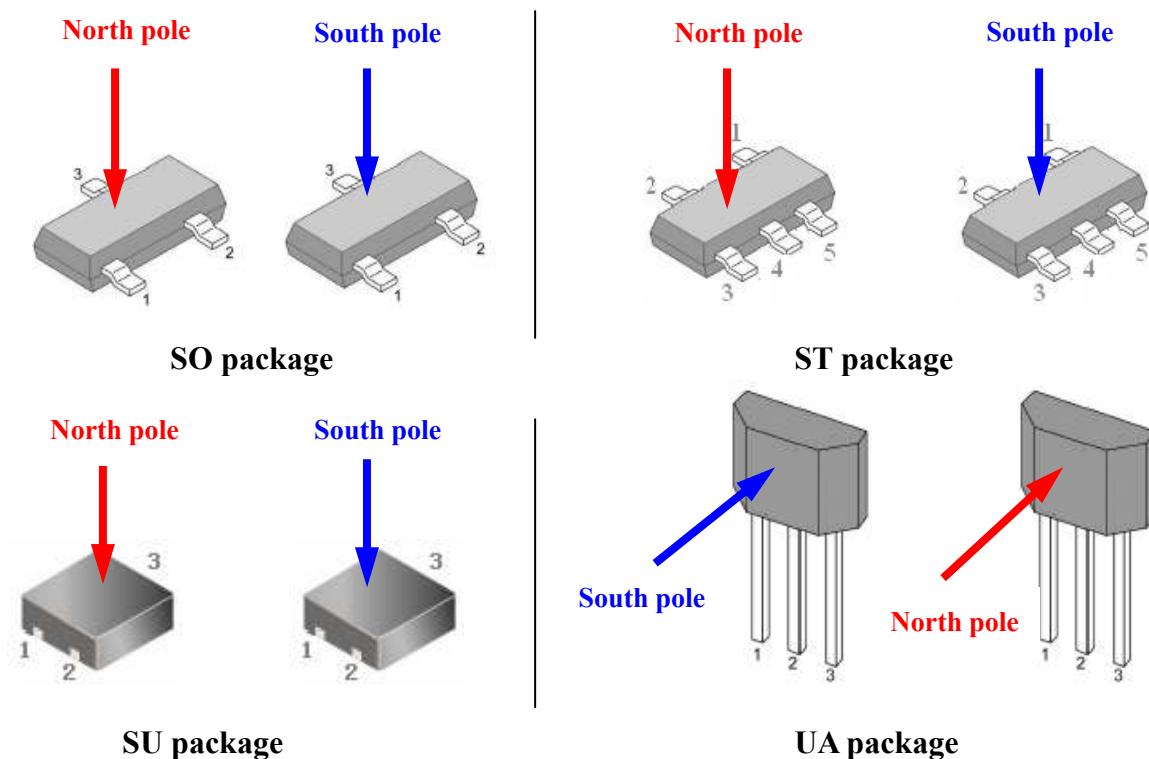
| Parameter                   | Test condition               | OUT(SO/ST) | Test condition              | OUT(UA/SU) |
|-----------------------------|------------------------------|------------|-----------------------------|------------|
| South pole                  | $B > B_{OPN} [(-60) - (-6)]$ | low        | $B > B_{OPS}(6-60)$         | low        |
| Null or weak magnetic field | $B = 0$ or $B < B_{RP}$      | high       | $B = 0$ or $B < B_{RP}$     | high       |
| North pole                  | $B > B_{OPS} (6-60)$         | low        | $B > B_{OPN}[(-60) - (-6)]$ | low        |



**MH248ESO/UA/ST/SU- $\alpha$  Output Behavior versus Magnetic Polar**

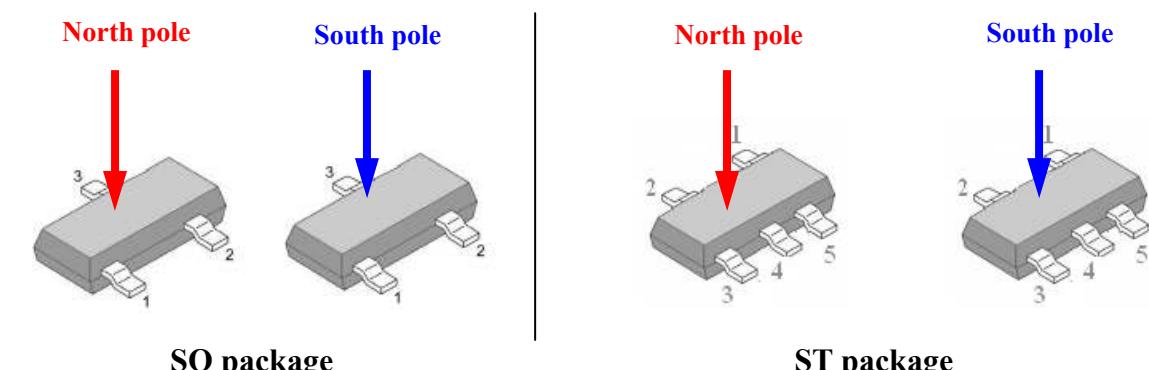
DC Operating Parameters Ta = -40 to 85°C, Vdd = 2.5 to 3V

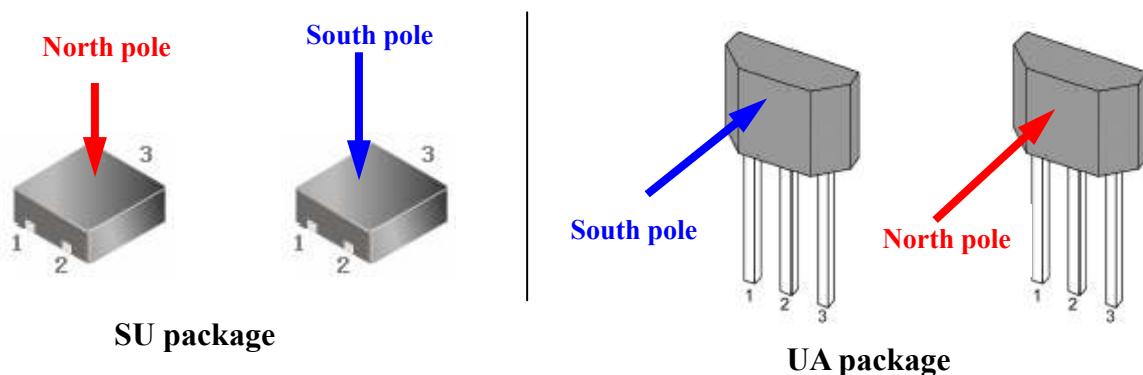
| <b>Parameter</b>            | <b>Test condition</b>           | <b>OUT(SO/ST)</b> | <b>Test condition</b>           | <b>OUT(UA/SU)</b> |
|-----------------------------|---------------------------------|-------------------|---------------------------------|-------------------|
| South pole                  | B>B <sub>OPN</sub> [(-60)-(-6)] | low               | B>B <sub>OPS</sub> (21-40)      | low               |
| Null or weak magnetic field | B=0 or B < B <sub>RP</sub>      | high              | B=0 or B < B <sub>RP</sub>      | high              |
| North pole                  | B>B <sub>OPS</sub> (21-40)      | low               | B>B <sub>OPN</sub> [(-60)-(-6)] | low               |


**MH248ESO/UA/ST/SU- $\gamma$  Output Behavior versus Magnetic Polar**

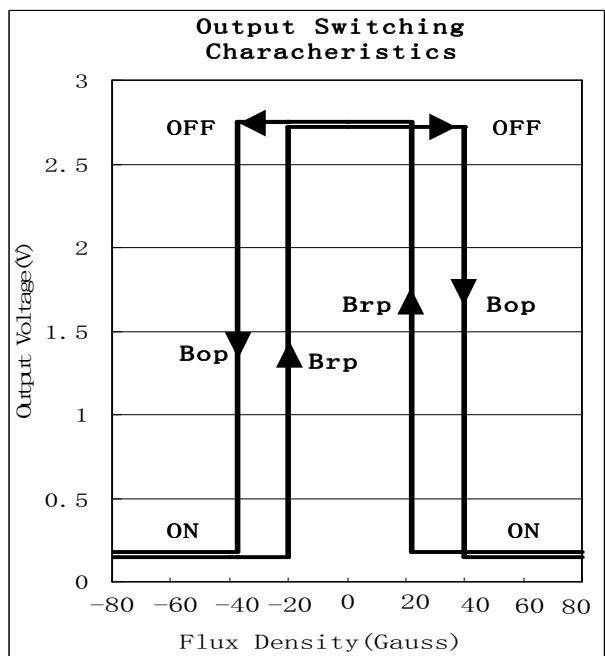
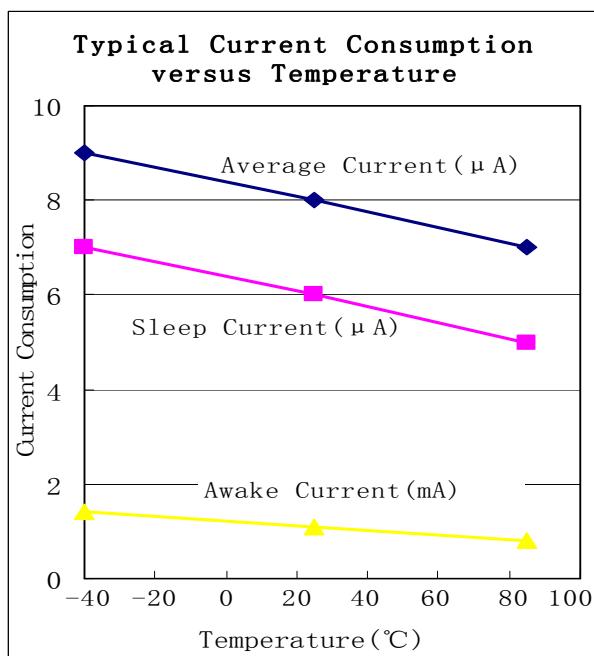
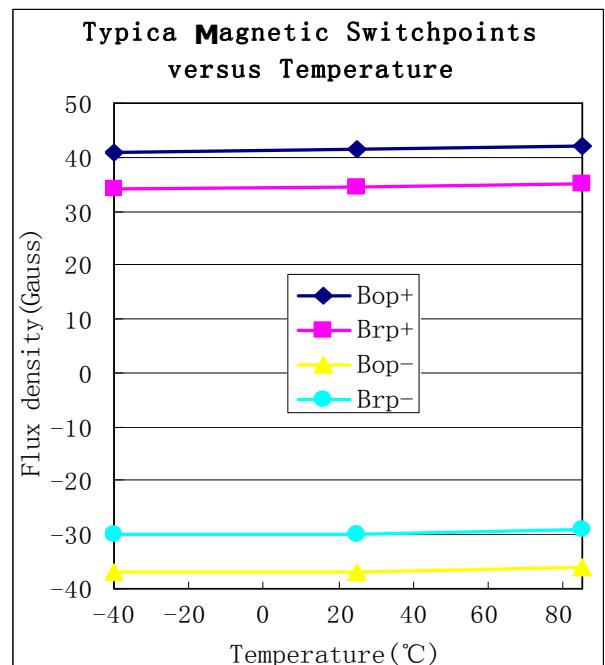
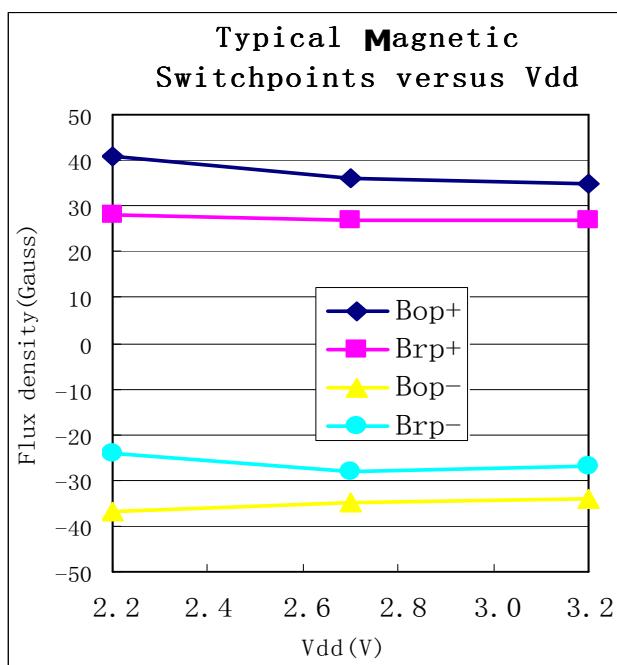
DC Operating Parameters Ta = -40 to 85°C, Vdd = 2.5 to 3V

| <b>Parameter</b>            | <b>Test condition</b>           | <b>OUT(SO/ST)</b> | <b>Test condition</b>           | <b>OUT(UA/SU)</b> |
|-----------------------------|---------------------------------|-------------------|---------------------------------|-------------------|
| South pole                  | B>B <sub>OPN</sub> [(-60)-(-6)] | low               | B>B <sub>OPS</sub> (6-35)       | low               |
| Null or weak magnetic field | B=0 or B < B <sub>RP</sub>      | high              | B=0 or B < B <sub>RP</sub>      | high              |
| North pole                  | B>B <sub>OPS</sub> (6-35)       | low               | B>B <sub>OPN</sub> [(-60)-(-6)] | low               |



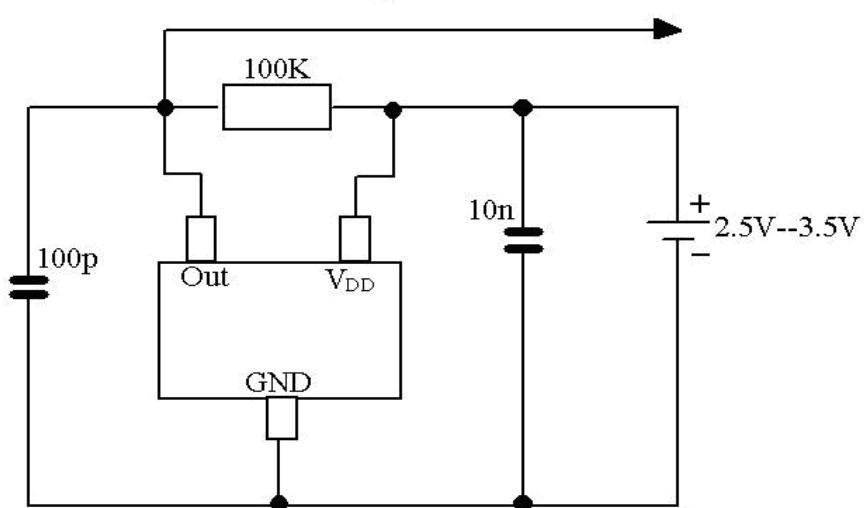
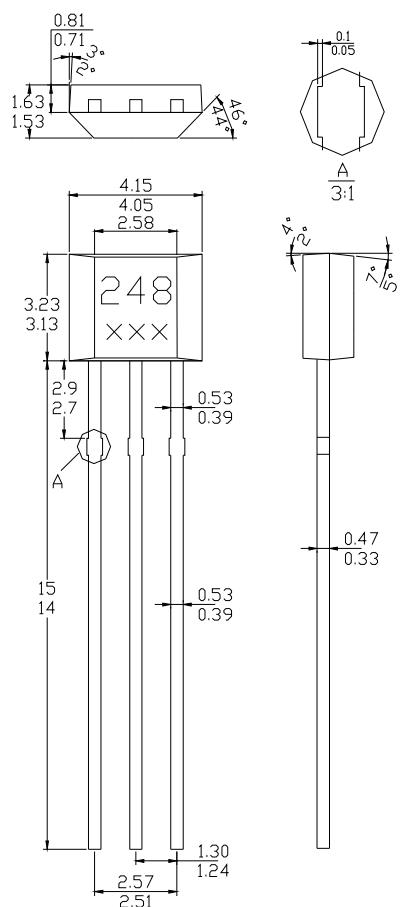


### Performance Graphs



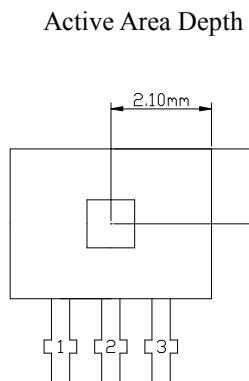
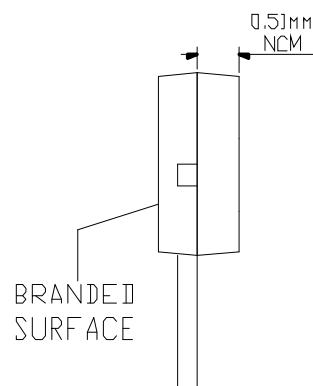
**Installation Comments**

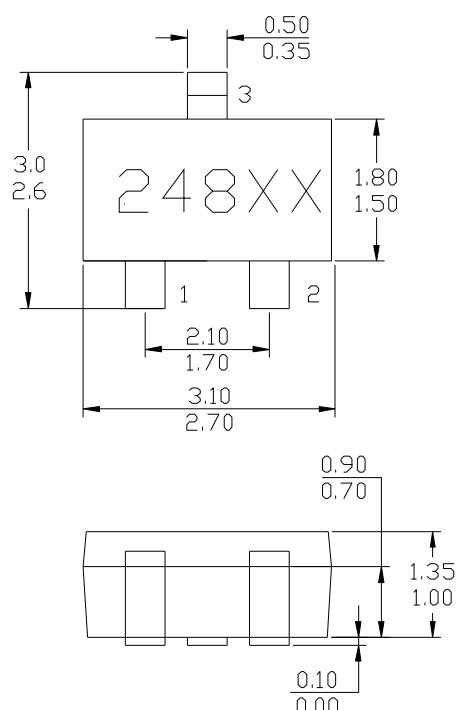
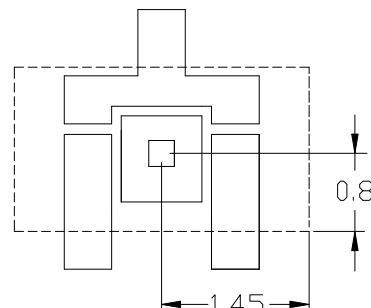
Consider temperature coefficients of Hall IC and magnetic, as well as air gap and life time variations. Observe temperature limits during wave soldering.

**Typical Application**

**Sensor Location, package dimension and marking**
**MH 248 UA-01 Package**

**NOTES:**

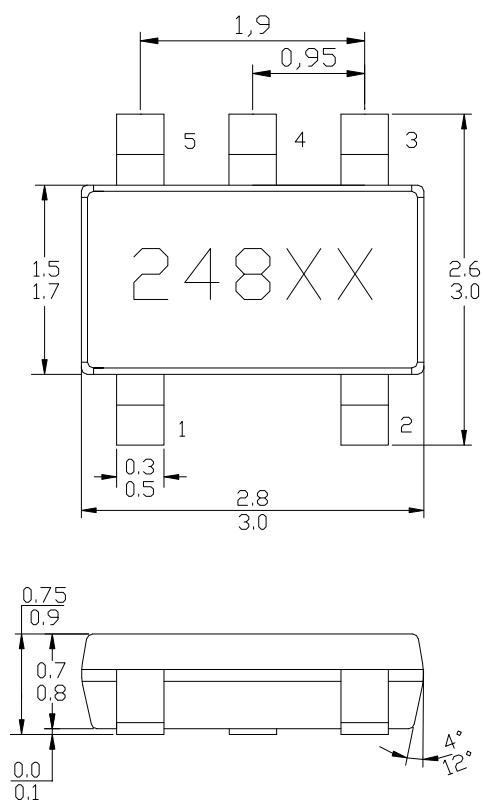
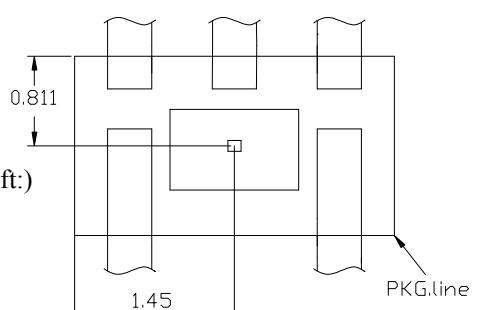
1. Controlling dimension: mm
2. Leads must be free of flash and plating voids
3. Do not bend leads within 1 mm of lead to package interface
4. PINOUT:
 

|       |                 |
|-------|-----------------|
| Pin 1 | V <sub>DD</sub> |
| Pin 2 | GND             |
| Pin 3 | Output          |


**Sensor Location**

**MH 248 SO-05 Package**
**(Top View)**

**SOT-23 Hall Plate / Chip Location**
**(Bottom view)**

**NOTES:**

1. PINOUT (See Top View at left:)  
Pin 1 VDD  
Pin 2 Output  
Pin 3 GND
2. Controlling dimension: mm;
3. Lead thickness after solder plating will be 0.254mm maximum.

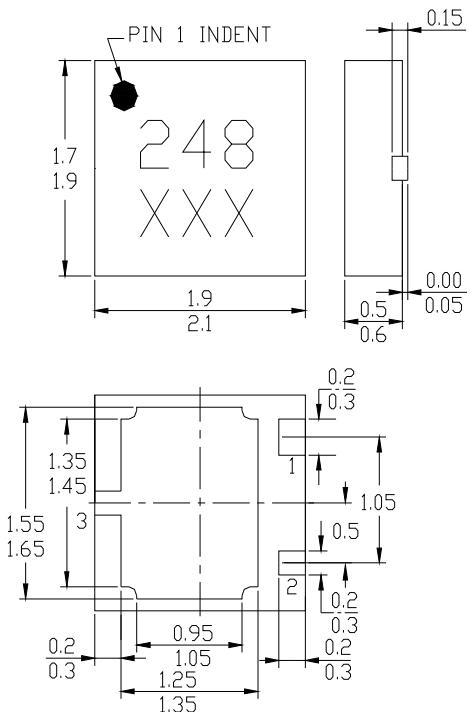
**MH 248 ST-06 Package**
**TSOT-25 Package Dimension**
**(Top View)**

**TSOT-25 Hall Plate / Chip Location**
**(Bottom view)**

**NOTES:**

1. PINOUT (See Top View at left:)  
Pin 1 VDD  
Pin 2 Output  
Pin 3 NC  
Pin 4 GND  
Pin 5 NC
2. Controlling dimension: mm;
3. Chip rubbing will be 10mil maximum;
4. Chip must be in PKG. center.

MH 248 SU-07 Package

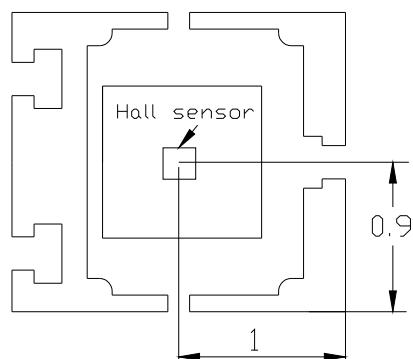
## **USON Package Dimension**

**(Top View)**



## **USON Hall Plate / Chip Location**

(Bottom view)

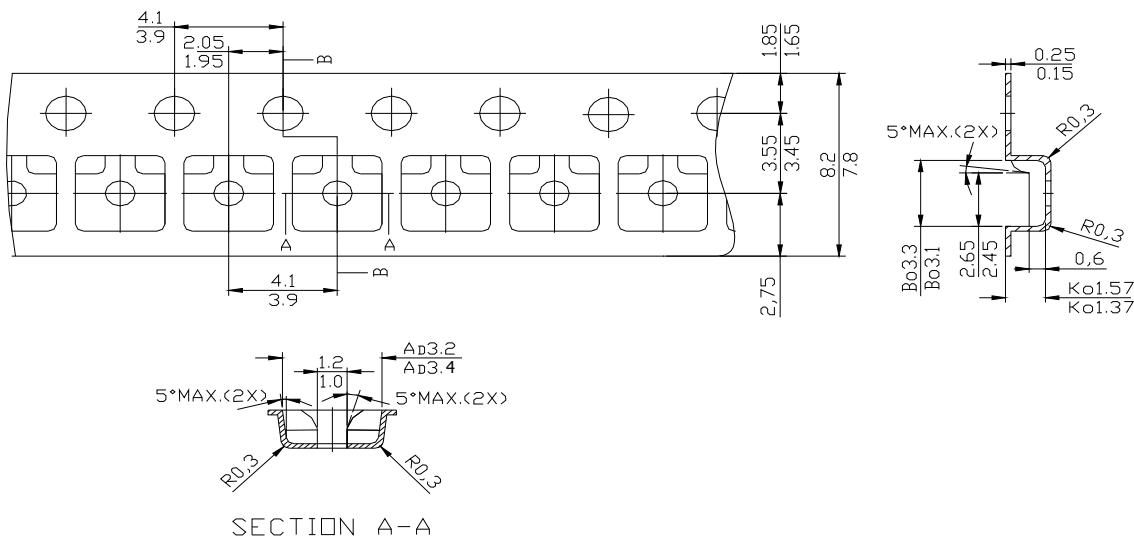


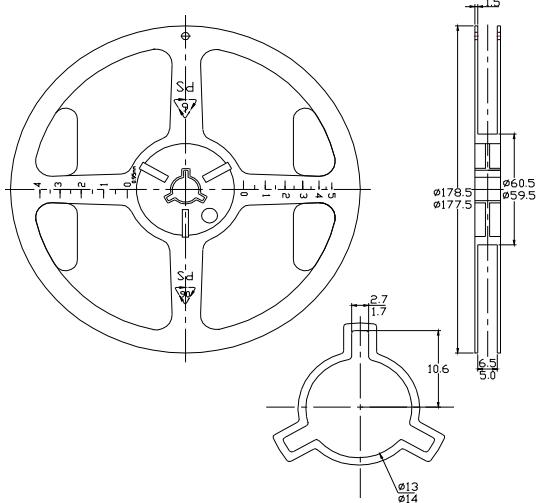
#### **NOTES:**

1. PINOUT (See Top View at left:)

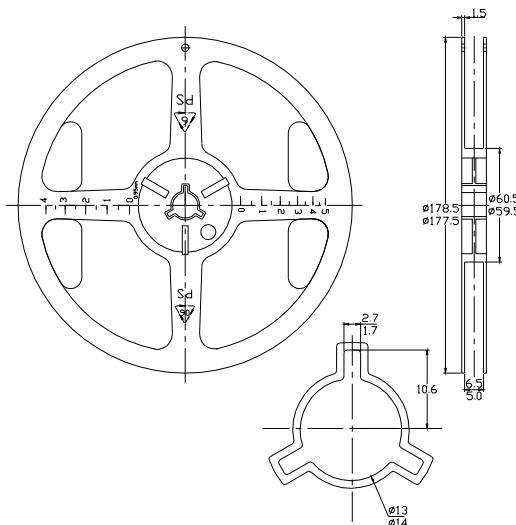
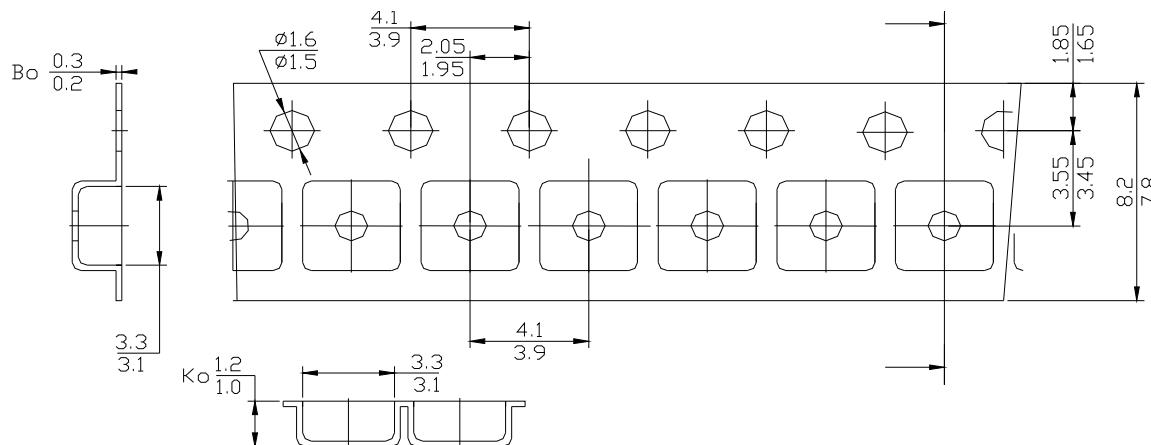
|       |        |
|-------|--------|
| Pin 1 | VDD    |
| Pin 2 | Output |
| Pin 3 | GND    |
  2. Controlling dimension: mm;
  3. Chip rubbing will be 10mil maximum;
  4. Chip must be in PKG. center.

## Sot 23 package Tape On Reel Dimension

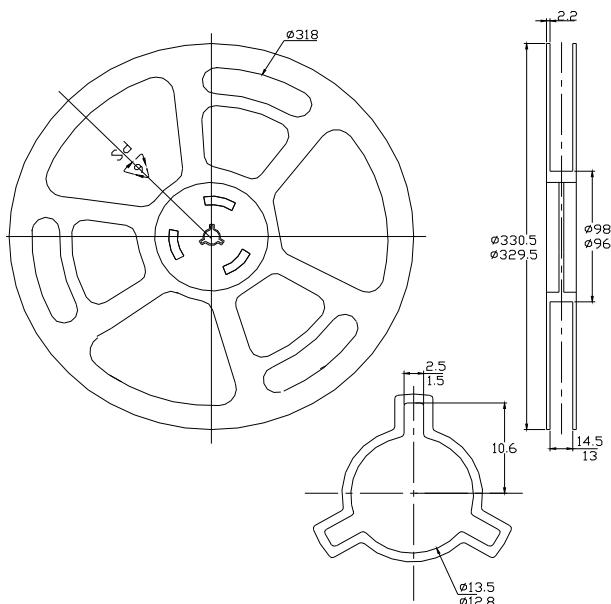
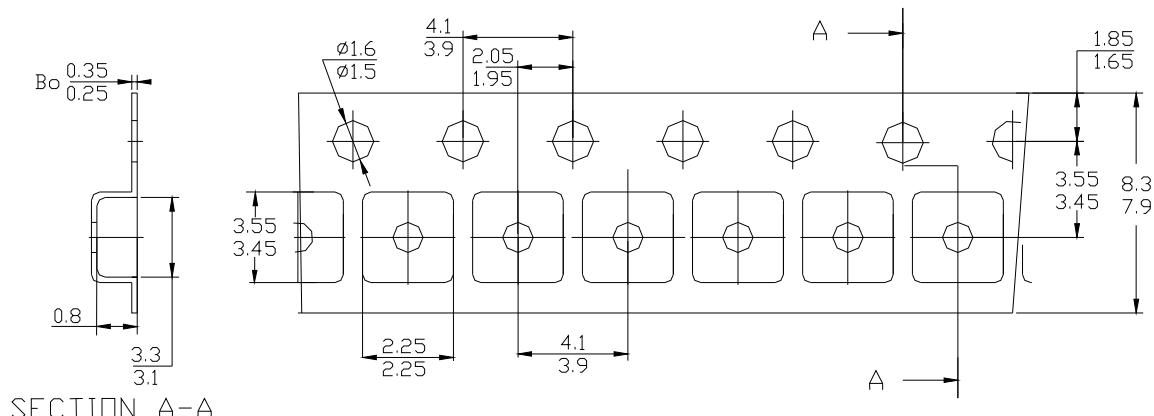



**NOTES:**

1. Material: Conductive polystyrene;
2. DIM in mm;
3. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ ;
4. Camber not to exceed 1mm in 100mm;
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole;
6. (S.R. OHM/SQ) Means surface

**TSot 25 package Tape On Reel Dimension**

**NOTES:**

1. Material: Conductive polystyrene;
2. DIM in mm;
3. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ ;
4. Camber not to exceed 1mm in 100mm;
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole;
6. (S.R. OHM/SQ) Means surface electric resistivity of the carrier tape.

**USON package Tape On Reel Dimension**

**NOTES:**

1. Material: Conductive polystyrene;
2. DIM in mm;
3. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ ;
4. Camber not to exceed 1mm in 100mm;
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole;
6. (S.R. OHM/SQ) Means surface electric resistivity of the carrier tape.

**MH 248 Labeling on ESD beg in different selection**
**MH 248ESO/UA/ST/SU**

|  |  |  |  |
|--|--|--|--|
| <br>MSL1 260°C  | P/N: MH-248EUA<br>Sorting:<br>Pkg Idf: 01<br>Lot No.:<br>Date Code:<br>Quantity: | <br>MSL 1 260°C | P/N: MH-248ESO<br>Sorting:<br>Pkg Idf: 05<br>Lot No.:<br>Date Code:<br>Quantity: |
| <br>MSL 1 260°C | P/N: MH-248EST<br>Sorting:<br>Pkg Idf: 06<br>Lot No.:<br>Date Code:<br>Quantity: | <br>MSL 1 260°C | P/N: MH-248ESU<br>Sorting:<br>Pkg Idf: 07<br>Lot No.:<br>Date Code:<br>Quantity: |

**MH 248ESO/UA/ST/SU- $\alpha$** 

|   |  |   |  |
|---|--|---|--|
|  | P/N: MH-248EUA   |  | P/N: MH-248ESO   |
|  | Sorting: a<br>Pkg Idf: 01<br>Lot No.:<br>Date Code:<br>Quantity: |  | Sorting: a<br>Pkg Idf: 05<br>Lot No.:<br>Date Code:<br>Quantity: |
| MSL1 260°C  |  | MSL 1 260°C   |  |
|  | P/N: MH-248EST   |  | P/N: MH-248ESU   |
|  | Sorting: a<br>Pkg Idf: 06<br>Lot No.:<br>Date Code:<br>Quantity: |  | Sorting: a<br>Pkg Idf: 07<br>Lot No.:<br>Date Code:<br>Quantity: |
| MSL 1 260°C   |  | MSL 1 260°C   |  |

**MH 248ESO/UA/ST/SU- $\gamma$** 

|   |   |   |   |
|---|---|---|---|
|    | P/N: MH-248EUA  |    | P/N: MH-248ESO  |
|   | Sorting: $\gamma$<br>Pkg Idf: 01<br>Lot No.:<br>Date Code:<br>Quantity: |   | Sorting: $\gamma$<br>Pkg Idf: 05<br>Lot No.:<br>Date Code:<br>Quantity: |
| MSL1 260°C  |   | MSL 1 260°C   |   |
|  | P/N: MH-248EST  |  | P/N: MH-248ESU  |
|  | Sorting: $\gamma$<br>Pkg Idf: 06<br>Lot No.:<br>Date Code:<br>Quantity: |  | Sorting: $\gamma$<br>Pkg Idf: 07<br>Lot No.:<br>Date Code:<br>Quantity: |
| MSL 1 260°C   |   | MSL 1 260°C   |   |